

ACTS04MS

TOP VIEW

Radiation Hardened Hex Inverter

January 1996

(Typ)

Features **Pinouts** • Devices QML Qualified in Accordance with MIL-PRF-38535 14 PIN CERAMIC DUAL-IN-LINE MIL-STD-1835 **DESIGNATOR CDIP2-T14, LEAD FINISH C** • Detailed Electrical and Screening Requirements are Contained in SMD# 5962-96712 and Intersil's QM Plan 1.25 Micron Radiation Hardened SOS CMOS Single Event Upset (SEU) Immunity: <1 x 10⁻¹⁰ Errors/Bit/Day • Latch-Up Free Under Any Conditions Military Temperature Range-55°C to +125°C Significant Power Reduction Compared to ALSTTL Logic A1 __________ DC Operating Voltage Range 4.5V to 5.5V

- Input Logic Levels
 - VIL = 0.8V Max
 - VIH = VCC/2 Min
- Input Current ≤ 1µA at VOL, VOH
- Fast Propagation Delay 14ns (Max), 9ns (Typ)

Description

The Intersil ACTS04MS is a Radiation Hardened Hex Inverter.

The ACTS04MS utilizes advanced CMOS/SOS technology to achieve high-speed operation. This device is a member of radiation hardened, high-speed, CMOS/SOS Logic Family.

The ACTS04MS is supplied in a 14 lead Ceramic Flatpack (K suffix) or a Ceramic Dual-In-Line Package (D suffix).



Functional Diagram



Ordering Information

PART NUMBER	TEMPERATURE RANGE	SCREENING LEVEL	PACKAGE
5962F9671201VCC	-55°C to +125°C	MIL-PRF-38535 Class V	14 Lead SBDIP
5962F9671201VXC	-55°C to +125°C	MIL-PRF-38535 Class V	14 Lead Ceramic Flatpack
ACTS04D/Sample	25°C	Sample	14 Lead SBDIP
ACTS04K/Sample	25°C	Sample	14 Lead Ceramic Flatpack
ACTS04HMSR	25°C	Die	Die

CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. 1-888-INTERSIL or 321-724-7143 | Intersil and Design is a trademark of Intersil Americas Inc. Copyright © Intersil Americas Inc. 2001, All Rights Reserved 1 1

Die Characteristics

DIE DIMENSIONS:

88 mils x 88 mils 2240mm x 2240mm

METALLIZATION:

Type: AlSi Metal 1 Thickness: 7.125kÅ ±1.125kÅ Metal 2 Thickness: 9kÅ ±1kÅ

GLASSIVATION:

Type: SiO₂ Thickness: 8kÅ ±1kÅ

WORST CASE CURRENT DENSITY:

 $<2.0 \text{ x} 10^5 \text{ A/cm}^2$

BOND PAD SIZE:

4.3 mils x 4.3 mils

> 110µm x 110µm

Metallization Mask Layout



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